

## Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(on)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

## Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

## General Features

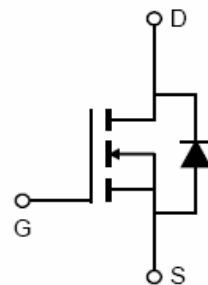
- $V_{DS} = 120V, I_D = 130A$
- $R_{DS(on)} = 4.5m\Omega$ , typical (TO-220)@  $V_{GS} = 10V$
- $R_{DS(on)} = 4.3m\Omega$ , typical (TO-263)@  $V_{GS} = 10V$
- Excellent gate charge  $\times R_{DS(on)}$  product(FOM)
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating



TO-220C



TO-263



Schematic Diagram

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST12N043-TC	VST12N043	TO-220C	-	-	-
VST12N043-T3	VST12N043	TO-263	-	-	-

## Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	120	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	130	A
Drain Current-Continuous( $T_c=100^\circ C$ )	$I_D(100^\circ C)$	93	A
Pulsed Drain Current	$I_{DM}$	520	A
Maximum Power Dissipation	$P_D$	220	W
Derating factor		1.47	W/ $^\circ C$
Single pulse avalanche energy (Note 5)	$E_{AS}$	1050	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	$^\circ C$

## Thermal Characteristic

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	0.68	°C/W
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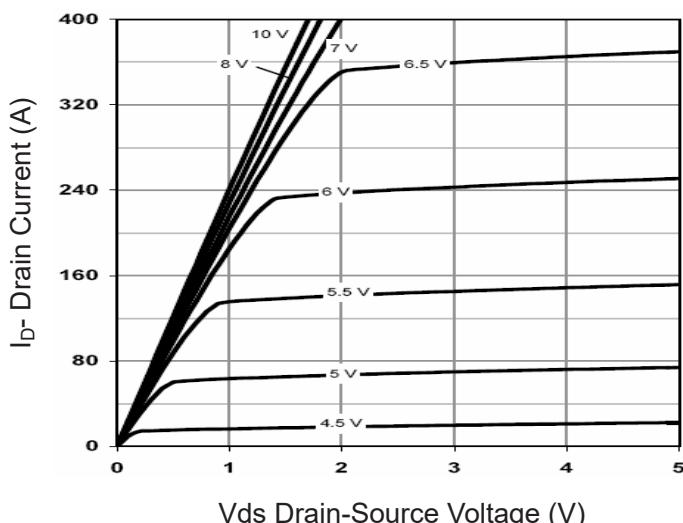
## Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
<b>Off Characteristics</b>							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	120		-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =120V, V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA	
<b>On Characteristics</b> <sup>(Note 3)</sup>							
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0	3.0	4.0	V	
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =65A	TO-220	-	4.5	5.0	mΩ
			TO-263		4.3	5.0	mΩ
Forward Transconductance	g <sub>F</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =65A	85	-	-	S	
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>							
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V, F=1.0MHz	-	6880	-	PF	
Output Capacitance	C <sub>oss</sub>		-	450	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	22	-	PF	
<b>Switching Characteristics</b> <sup>(Note 4)</sup>							
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =60V, I <sub>D</sub> =65A V <sub>GS</sub> =10V, R <sub>G</sub> =1.6Ω	-	20	-	nS	
Turn-on Rise Time	t <sub>r</sub>		-	11.5	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	48	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS	
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =60V, I <sub>D</sub> =65A, V <sub>GS</sub> =10V	-	112	-	nC	
Gate-Source Charge	Q <sub>gs</sub>		-	36	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>		-	27	-	nC	
<b>Drain-Source Diode Characteristics</b>							
Diode Forward Voltage <sup>(Note 3)</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =65A	-		1.2	V	
Diode Forward Current <sup>(Note 2)</sup>	I <sub>S</sub>		-	-	130	A	
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = I <sub>S</sub> di/dt = 100A/μs <sup>(Note 3)</sup>	-	76	-	nS	
Reverse Recovery Charge	Q <sub>rr</sub>		-	150	-	nC	

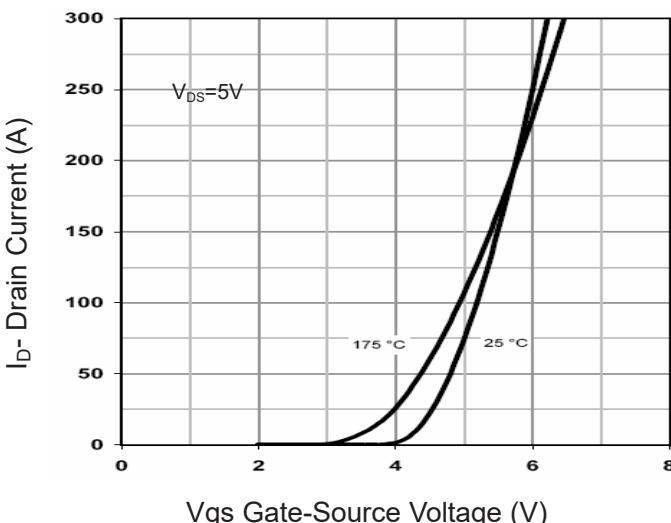
## Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition : T<sub>j</sub>=25°C, V<sub>DD</sub>=50V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω

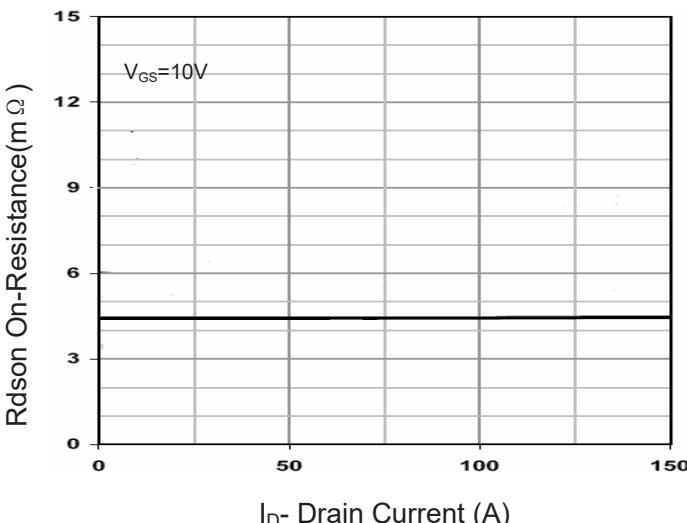
### Typical Electrical and Thermal Characteristics



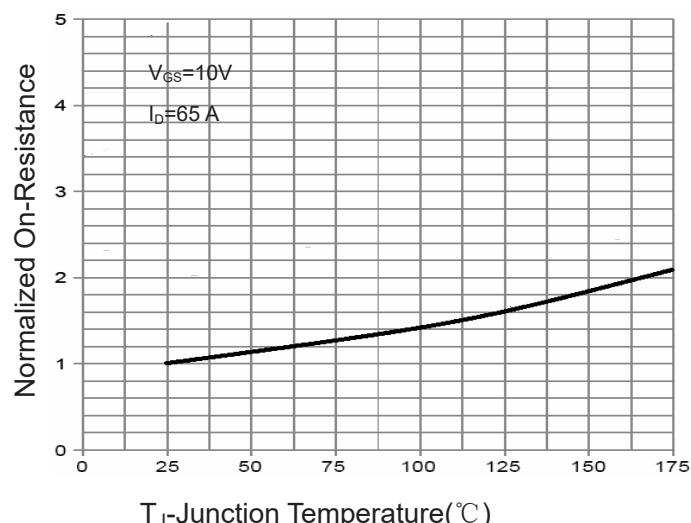
**Figure 1 Output Characteristics**



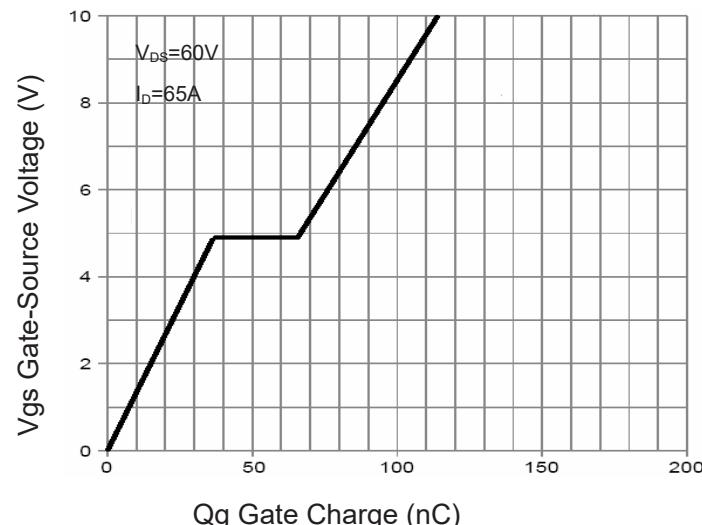
**Figure 2 Transfer Characteristics**



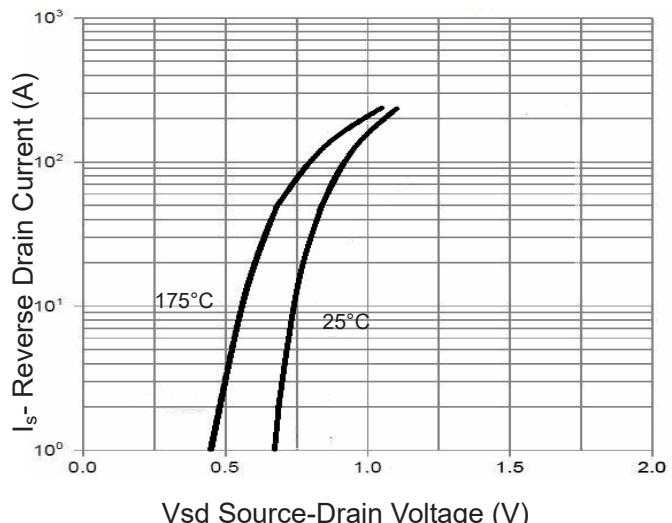
**Figure 3 Rdson- Drain Current**



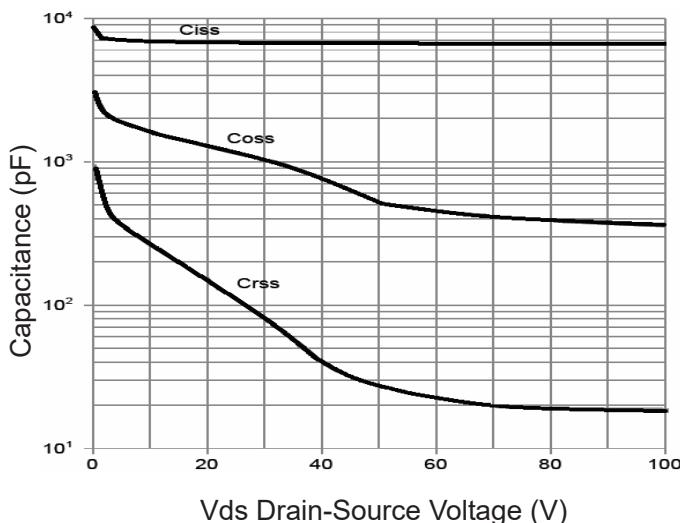
**Figure 4 Rdson-Junction Temperature**



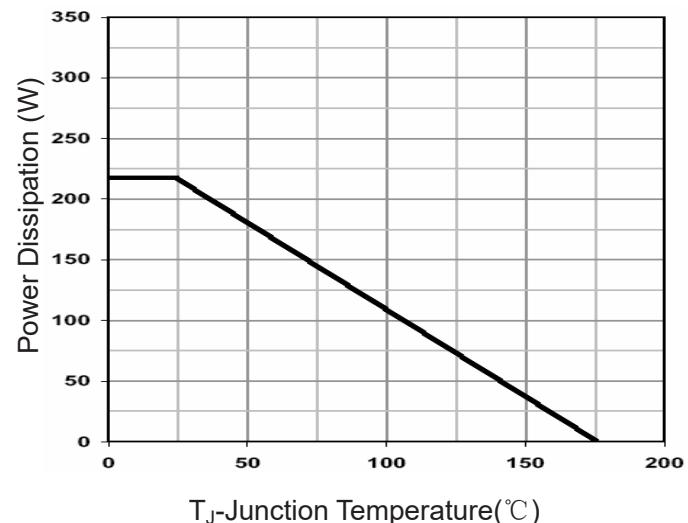
**Figure 5 Gate Charge**



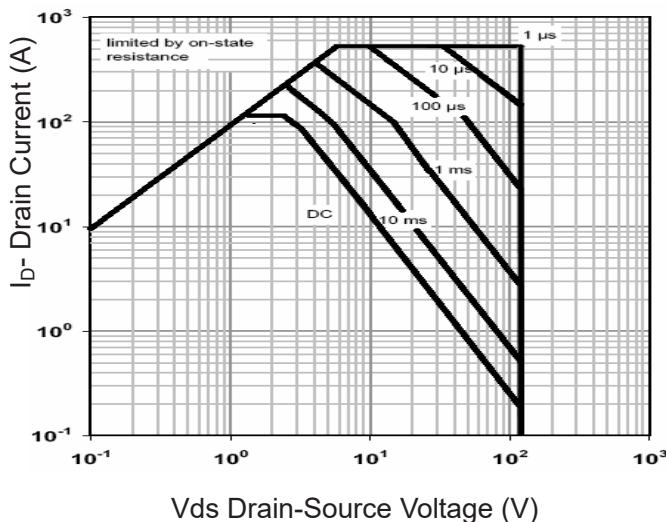
**Figure 6 Source- Drain Diode Forward**



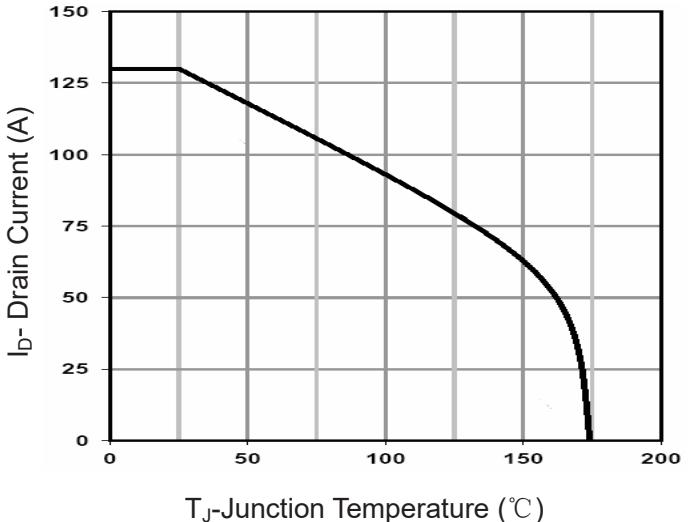
**Figure 7 Capacitance vs Vds**



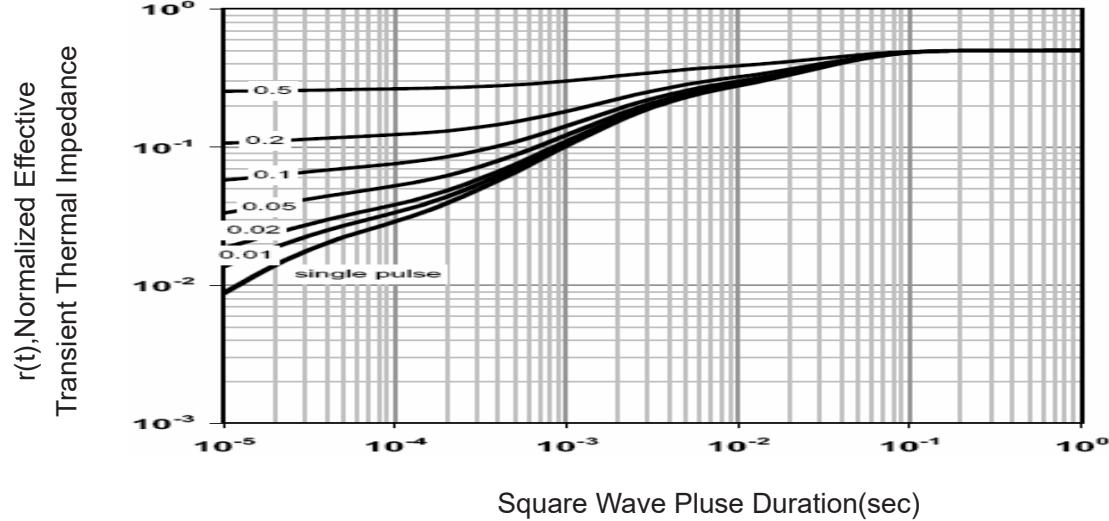
**Figure 9 Power De-rating**



**Figure 8 Safe Operation Area**



**Figure 10 Current De-rating**



**Figure 11 Normalized Maximum Transient Thermal Impedance**